Customer: 立创

[New Released, Revised]

SPECIFICATIONS

Product		
Name:	SMD Power Inductors	
SXN		
Part Number:	SM7850-4R7MT	
Customer		
Part Number	SM7850-4R7MT	

【For Customer approval Only】 Date:				
	Approved By	Verified By	Re-checked By	Checked By

Approved By	Checked By	Issued By

SPECIFICATION FOR APPROVAL

CUSTOMER:	立创		PAGE: 2 C	OF 8	
SXN P/N: SM	7850-4R7MT	LOT NO:			
1.MECHANIC	AL DIMENSIONS DRAV	V NO:SM7850	Item	Spec(mm)	Ref.
			Α	7.8±0.3	
- B	MARKING C (印字)		В	7.0±0.3	
~~			С	5.0±0.5	
		<u> </u>	D		
l (×)	/ 	(\$18188)	Е		
00115140710	7.5	CMO	F		
SCHEMATIC 1 • •	7.5	2.0 2.0 2.7 5.	G		
原理圖			Н		
) \ \lambda		W W W *	ı		
الـــه 2	BACK-BACK-BACK-BACK-BACK-BACK-BACK-BACK-	HTAPE: 1000 PCS	Marking:		
			黑色字体	"4R7"	
2.ELECTRICA	AL CHARACTERISTICS:				
Item	Spec	Ref.		Test Equi	pments
L	4.7uH ±20%	4.68uH	VR1153 l	_CR+DCR	
Test Freq L load	<u>L@100KHZ/0. 25V</u> L+3.5A:L DROP20%Max	4.29uH	\/D1153	& VR7210	
Test Freq	L@100KHZ/0. 25V	4.29011	VK1155	Q VK1210	
DCR	0.055oHM Max	45.36mΩ	VR1153 l	_CR+DCR	
Turn	11.5T (REF)				
Ope.Temp	-20 TO 80℃				
	20 10 00 0				
CUST	LOMER APPROVED	APPROVED	CHE	ECKED	DRAWN
		7	0		
ISSUE DATE:	:17/Jul/17 PRINT	DATE: 17/Jul/17	l	REV	:1.0
					FRM-ZFFNG-007

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A written notice is needed immediately, whenever there is a changing to product specification. We won't answer for any consequences unless the written notice is received by our company before production.

CUSTOMER: 立创						PAGE: 3 OF 8
SXN P/N: SM7850-4R					LOT NO:	
3.MAIN MATERIALS & S	SUPPL	.IERS:				
Item			Supp	oter		SGS No
1-CD7.8*5.0*3.0-UN	UNIT	ED ELE	CTRO	VICS	S CO.,LTD	RLSZD00079387000
2-2UEWH-0.40mm	ELEK	TRISOL	SA(MA	\LA\	YSIA)SDN.BHD	CE/2011/45621A
3-SOLDERWIRE-SnCu	SHE	N ZHEN	QIAN 7	ΓΙΑΝ	SOLDER CO.	CANEC1100526701
4.PACKAGING MATERIA	108-	SLIDDI	IEDQ:			
5-REEL-13"xW16MM		SHING(F		או וכ	TDIAI	
3-KEEL-13 XVV TOIVIIVI	СПЗ	эпій (г	1.rx <i>)</i> 1111		DIRIAL	
5-CARRIER-SM7850	CHI S	SHING(F	ł.K) INI	ous	STRIAL	
5-COVER-13.3MM	CHI S	SHING(F	I.K) INI	DUS	STRIAL	
						_
5.NOTES:		APPR	OVED		CHECKED	DRAWN
ISSUE DATE: 17/Jul/17	,	PRIN ⁻	T D/17/	/Jul/	17 <u> </u>	REV:1.0

FRM-ZFENG-007

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SPECIFICATION FOR APPROVAL

CUSTOM	IER :	立创							PAGE	: 4 OF	8
SXN P / N	١ :	SM7850-4R7MT							DATE :	17/Jul/	17
LOT NO	:						SHAPI	Ξ:			
QUANTIT	Υ :	1	0				B	MARKING (印字)	C	Æ	A1635
TEST FR	EQ.:		L@10	0KHz/0.	25V		XX	Æ		# <u>#</u>	81888 81888
COIL DE	SCRIPTIO	N :					SCHEMAT	IC 7.5	4.0.	12.0 . 2.0	3V 21
WIRE:	0.4	mm	TURN:	11	.5	Ts	月 0 ● ○ ○ ○ ○ ○ ○ ○ ○ ○ ○ ○ ○ ○ ○ ○ ○ ○ ○	LAYBur			
TEMP:	23	$^{\circ}\!\mathbb{C}$	HUMI:	3	7	%	2 0		EA EA	OH TAPE: 1000 PCS	***
ELECTRI	CAL CHA	RACTERIS	TICS AND	MECH.	ANICAL	DIMEN	SIONS	(m/m)	:		
ITEM	L	L+3.5A	DCR	Α	В	С	D	Ε	F	G	Н
SPEC	4.7uH	4.7uH	55	7.8	7.0	5.0					
TOL.	±20%	±20%	mΩ	±0.3	±0.3	±0.5					
1	4.75	4.45	47.35	7.72	7.08	5.14					
2	4.78	4.56	48.01	7.73	7.08	5.14					
3	4.80	4.48	48.52	7.72	7.06	5.16					
4	4.81	4.39	47.69	7.71	7.07	5.15					
5	4.79	4.52	47.85	7.72	7.09	5.16					
6	4.76	4.52	49.05	7.73	7.08	5.14					
7	4.69	4.57	49.12	7.74	7.08	5.14					
8	4.68	4.40	48.25	7.73	7.07	5.16					
9	4.70	4.38	47.98	7.73	7.08	5.16					
10	4.75	4.29	45.36	7.72	7.08	5.14					
Max	4.81	4.57	49.12	7.74	7.09	5.16					
Min	4.68	4.29	45.36	7.71	7.06	5.14					
X	4.75	4.45	47.92	7.73	7.08	5.15					
JUDGE	OK	OK	OK	OK	OK	OK					
								APPR	OVED	INSPE	CTED

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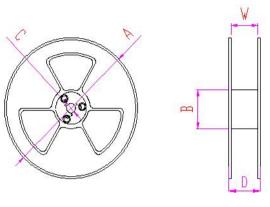
PACKAGING

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DATE: 17/Jul/17

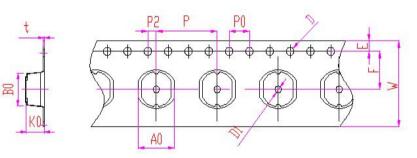
1. 每卷轴包装数量:1000PCS/R (开始与结尾留空30~40cm不装COIL), 贴上正确的标签,卷轴及载带





卷轮尺寸(REEL DIMENSIONS)一般公差±0.5mm

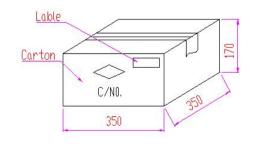
图 107 (1 (1 (1 (1 (1 (1 (1 (1 (1 (
Α	В	С	W	D			
Ф330	Ф100	Ф13.5	16.5	22.5			





载帶尺寸(TAPE DIMENSIONS):

W	A0	В0	K0	Р	F	Е	D	D1	P0	P2	t
16±0.3	7.4±0.1	8.2±0.1	5.6±0.1	12±0.1	7.5±0.1	1.75±0.1	1.5+0.1	1.5+0.1	4.0±0.1	2.0±0.1	0.4±0.05



FRM-ENGRD-007

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RELIABILITY TEST CONDITIONS

FOR	SMT/SMD PRODUCTS		PAGE: 60F 8
	Item (項目)	Required Characteristics (要求)	Test Method / Condition (測試方法)
	High temperature Storage test	1.No case deformation or change in appearance. $2.\Delta L/L \le 10\%$	Temperature: 85±2℃ Time : 96±2 hours Tested not less than 1 hour, nor more than 2 hours at room tempe
	Reference documents: MIL-STD-202G Method 108A		Temp 85°C High temperature Room Temp 1H
	高溫儲存試驗	1.無明顯的外觀缺陷 2.感值變化不超過10%	0 96H Test Time 温度: 85±2°C 時間: 96±2 小時 樣品在室溫下放置1小時,不超2小時間必須測試.
	Low temperature Storage test	1.No case deformation or change in appearance. 2. Δ L/L \leq 10%	Temperature: -25±2°C Time: 96±2 hours Tested not less than 1 hour, nor more than 2 hours at room temperature.
	Reference documents: IEC 68-2-1A 6.1 6.2		Temp 0 96H Test Time Low temperature
(環境試驗)	低溫儲存試驗	1.無明顯的外觀缺陷 2.感值變化不超過10% 3.品質因數變化不超過30%	▼ Temp溫度: -25±2℃時間: 96±2 小時樣品在室溫下放置1小時,不超2小時間必須測試.
vironmental tests (環境試驗)	Humidity test	1.No case deformation or change in appearance. $2.\Delta L/L \leqq 10\%$ $3.\Delta Q/Q \leqq 30\%$	 1. Dry oven at a temperature of 40° ±5°C for 24 hours. 2. Measurements At the end of this period 3. Exposure:Temperature: 40±2°C
En	Reference documents: MIL-STD-202G Method 103B		40°C Temp & Humidity 93%RH High temperature High humidity 1H 96H Test Time
	濕度測試	1.無明顯的外觀缺陷 2.感值變化不超過10% 3.品質因數變化不超過30%	
			1.樣品必須先在40° ±5°條件下乾燥24小時 2.乾燥後測試 3.暴露: 溫度:40±2℃, 溼度: 93±3%RH Firs♥-40℃forT time, last125℃T time as 1 cycle.
	Thermal shock test	1.No case deformation or change in appearance. 2. Δ L/L \leq 10% 3. Δ Q/Q \leq 30%	Go through 20 cycles. Change time<5Min
		For T: weight ≦ 28g : 15Min; 28g ≦ weight ≦ 136g : 30Min	T2592
	熱衝擊測試	1.無明顯的外觀缺陷 2.感值變化小於10% 3.品質因數變化小於30%	在40°C Time Time 從-40°C 作用T分鐘,然後溫度衝擊到125°C 作用T分鐘,作 爲一個循環,共作用20次.

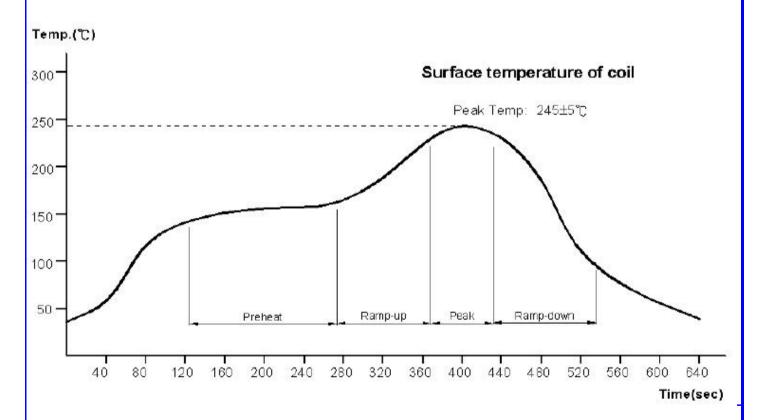
RELIABILITY TEST CONDITIONS

SMT/SMD PRODUCTS		PAGE: 70F 8
Item (項目)	Required Characteristics (要求)	Test Method / Condition (測試方法)
Solderability test Reference documents:	Terminals area must have 95% min. solder coverage	1.Dip pads in flux then dip in solder pot at 245±5°C for 5 seconds.
MIL-STD-202G Method 208H IPC J-STD-002B		2.Solder: Sn(63)/Pb(37) 3.Flux: ros 1.端子浸入助焊劑, 然後浸入245±5℃錫爐中5秒
可焊性測試	端子必須有95%以上著錫 1.No case deformation or change in appearance.	2.焊料:Sn(63)/Pb(37) 3.助焊劑: 松香助焊劑
Heat endurance of Reflow soldering	2.ΔL/L ≤ 10% 3.ΔQ/Q ≤ 30%	1.Refer to the next page reflow curve Go through 3 times 2.The peak temperature : 245±5°C
Reference documents: IPC J-STD-020B	4. △ DCR/DCR≦10% 1.無明顯的外觀缺陷 2.感值變化不超過10%	1.參照下頁回流焊曲線過三次
過再流焊測試	3.品質因數變化不超過30%	2.峰值溫度爲: 245±5℃ Apply frequency 10~55Hz. 0.75mm amplitude in each of perpendicular direction for 2 hours. (total 6 hours)
Vibration test Reference documents:	1.No case deformation or change in appearance. 2. \triangle L/L \leq 10% 3. \triangle Q/Q \leq 30%	Freq 55Hz
MIL-STD-202G Method 201A	4. △ DCR/DCR≦10% 1.無明顯的外觀缺陷	10Hz
振動測試	2.感值變化不超過10% 3.品質因數變化不超過30%	IMin Time
Drop test	1.No case deformation or change in appearance. 2. △ L/L ≦ 10%	Packaged & Drop down from 1m with 981m/s ² (100G) attitude 1 angle 1 ridges & 2 surfaces orientations.
Reference documents: MIL-STD-202G Method 203C	3. △ Q/Q ≤ 30% 4. △ DCR/DCR ≤ 10%	
落下試驗	1.無明顯的外觀缺陷 2.感值變化不超過10% 3.品質因數變化不超過30%	將產品包裝後從1米高度自然落下至試驗板上 1角1棱2面
Terminal strength push test	Pulling test: Define: A: sectional area of terminal A ≤ 8mm2 force ≥ 5N time: 30sec	Bend the testing PCB at middle point, the deflection shall be 2
romman outligan paon toot		Pulling test
Reference documents: JIS C 5321 :1997	Bending test: Soldering the products on PCB,after the pulling test and bending test ,terminal should not pull off	X 1.0
端子強度試驗	推力測試: 定義: A: 焊接端子截面積 A≤8mm2 推力≥5牛頓 時間: 30秒 8mm2 <a≤20mm2 10秒<="" td="" 推力≥10牛頓="" 時間:=""><td>Bending test Sample 將PCB對中彎折,到達撓度2mm.</td></a≤20mm2>	Bending test Sample 將PCB對中彎折,到達撓度2mm.
Resistance to solvent test Reference documents:	No case deformation or change in appearance,or obliteration of marking	To dip parts into IPA solvent for 5±0.5Min,then drying them a room temp for 5Min,at last ,to brushing making 10 times.
IEC 68-2-45:1993 耐溶劑性試驗	無外觀破壞及標記破損	在IPA溶劑中浸泡 5±0.5分鐘,室溫下乾燥5分鐘,然後拭10次.

RELIABILITY TEST CONDITIONS

FOR	SMT/SMD PRODUCTS		PAGE: 8 OF 8
	Item (項目)	Required Characteristics (要求)	Test Method / Condition (測試方法)
	Electronic characteristic test of major products	Refer to catalogue of specific products	Refer to catalogue of specific products
翻	主要產品電特性測試	參照具體產品目錄頁	參照具體產品目錄頁書
特性試	Overload test	During the test no smoke, no peculiar,smell, no fire The characteristic is normal after test	Apply twice as rated current for 5 minutes.
ests (電	Reference documents: JIS C5311-6.13		
teristic t	過負荷試驗	1.試驗過程中無冒煙,異味,著火等, 2.試驗後產品特性正常.	通兩倍額定電流 5 分鐘
Electrical Characteristic tests (電特性試驗)	voltage resistance test	During the test no breakdown The characteristic is normal after test	1.For parts with two coils 2.DC1000V,Current:1mA,Time:1Min.
Electric	Reference documents: MIL-STD-202G Mthod 301		
	絕緣耐壓測試	1.試驗過程中無擊穿 2.試驗後產品特性正常	1.只針對SMT二繞組以上 2.電壓DC1000V,電流1mA,時間1分鐘.

Curve of Heat endurance of Reflow soldering test



A test is made under the conditions mentioned above. And it is left 1 hour in the normal temperature and humidity. After that, no mechanical and electrical defeat should be found out. The reflow condition is according to the machine used by .